

CST2010A OTP-type Speech IC

1. CST2010A General Descriptions

CST2010A series are 4-bits micro-controller which could play 1 channel ADPCM with PWM direct drive circuit. PWM resolution is 8/10/12 bits. They include a low cost, high performance CMOS micro-processor. The clock frequency of this up is typically 4.096 (\pm 3%) MHz. This chip operates over a wide voltage range of 1.5V~5.5V. It contains program ROM (PROM) and data ROM (DROM) inside. The program ROM is 2K/4K words and data ROM size is 28K/24K bytes. The maximum working SRAM is (64+2) nibbles. It is provided with total 2 software programmable I/O Ports.

2. CST2010A Features

- □ Operating voltage: 1.5V to 5.5V
- □ MCU Operation frequency: 4.096 MHz
- □ Memory Size
 - □ Program ROM size: 2K/4K words OTP type
 - Data ROM size: 28K/24K bytes OTP type
 - □ SRAM size: 64*4 bits
 - □ User register: 2*4 bits
- Wakeup function for power-down mode:
- □ HALT mode wakeup source: Port A0 and Port A3 can wake up from HALT mode to NORMAL mode and executing wakeup sub-routine program.
- 2 input/output pins: Port A0 and Port A3 can be defined as input or output port bit by bit.
- Three reset condition:
- \Box Low voltage reset. (LVR = 1.5V)
- □ Power on reset.
- □ Watch dog timer overflow.
- One internal interrupt sources:
- PWM interrupt.
- WDT
 - □ Watch dog timer, can enabled/disabled by option.
- □ WDT period is 0.128 second.
- Audio output:
- □ Support 8/10/12-bit PWM mode.
- Support option set for pull down resistor 1M, 50K Ohm, low voltage reset...etc.
- Oscillator fuse option ±3%, temperature & voltage compensation.
- Support security option (1 bit) for read inhibition.



3. CST2010A Packaging and Pads Information

3.1 Pads

Туре	State After Reset	et Description				
ut						
Р	High	Power input.				
Р	Low	Ground input.				
5						
I/O	Z	Port A0 is a programmable input/output port				
I/O	Z Port A3 is a programmable input/out					
S						
0	Low	Audio output PWM(+).				
0	Low	Audio output PWM(-).				
	ut P P I/O I/O s O	ut P High P Low I/O Z I/O Z S Low				

Programming pad : PA0, PA3, PWMN, VCC, VSS

Table 1 Pad Description

3.2 Package

CST2010A provides SOT8 & SOT23-6

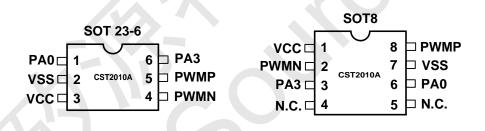
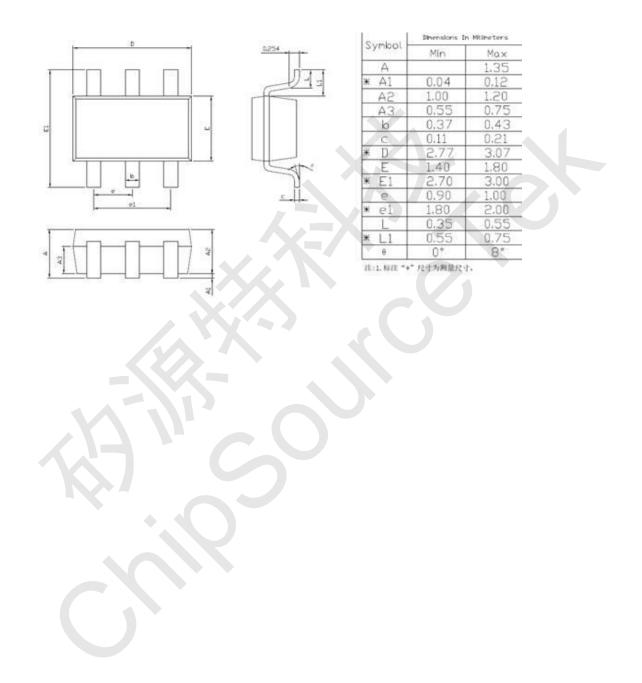


Figure 1. SOT8 & SOT23-6 Package



3.2 SOT23-6





3.3 Block Diagram

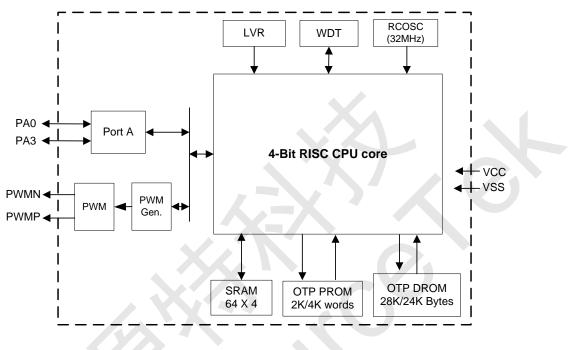


Figure 2. Block diagram

4. CST2010A ELECTRICAL CHARACTERIST ICS

4.1 Absolute Maximum Ratings

Parameters	Symbol	Value	Unit
DC Supply Voltage	Vcc	-0.5 to 6.0	V
Input Voltage	Vin	-0.5 to Vcc+0.5	V
Operating Temperature Range	Та	0 to +75	°C
Storage Temperature Range	Tstg	-25 to +85	°C

Table 2 Absolute Maximum Ratings

4.2 AC Characteristics

Parameters	Symbol	Minimum	Typical	Maximum
Operating Frequency	Fsys1	3.973MHz	4.096MHz	4.21MHz
RC reset time-constant	Trrc	-	10 us	-
Data ROM data ready time	Tdrr	-	-	2/Fsys
			•	

Table 3 AC Characteristics

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4.3 DC Characteristics

CC=3.0V, Ta=25°C unless otl Parameters		Minimum	Typical	Maximum	Condition
Power supply range	Vcc	1.5 V	-	5.5 V	
OTP Programming Power	Vpp	9.5 V	10 V	10.5 V	VCC = 4.8V
Supply current @VCC=3V	lop1		1.5mA		System clock 4.096MHz
Supply current @VCC=5V	lop2		1.55mA		PWM disabled
Stand-by Current	ISTBY		2.6uA		VCC=5.0V, MCU halt System clock off
Input high voltage	Vih1		0.6 VCC		Register SCHMIT=0
Input low voltage	Vil2		0.56 VCC		
Schmitt trigger Input high voltage	Vih2		0.64 VCC		Register SCHMIT=1
Schmitt trigger Input low voltage	Vil2		0.35 VCC	5	
Input leakage current	llk		0.1 uA		
Output high voltage	Voh	0.95 VCC			no load
Output low voltage	Vol			0.05 V	no load
Output high current in high source capacity mode	loh0		26mA		Vout=2.0 for PA0 and PA3 pin High source capacity
Output low current in high sink capacity mode	lol0		30mA		Vout=1.0 for PA0 and PA3 pin High sink capacity
PWM output load				8 ohm	Speaker impedance
Pull-down 50K resistance	Rpd1	-	53.5K Ohm		PA0 or PA3 pin with pull-down resistance. VCC=3V
Pull-down 1M resistance -1	Rpd2-1		1.04M Ohm		PA0 or PA3 pin with pull-down resistance. VCC=3V
Pull-down 1M resistance -2 (auto power saving mode)	Rpd2-2	C	3.45M Ohm		PA0 or PA3 pin with pull-down resistance, the resistance of 1M ohm will automatically increase to about 3.3M ohm after it's tied to 3V by external button-press @VCC=3V
Threshold voltage of low voltage reset circuit	Vlvr		1.5V		Low voltage reset circuit can't be disabled

VCC=3.0V, Ta=25°C unless otherwise noted

Table 4 DC Characteristics

5. CST2010A FUNCT IONAL DESCRIPT ION

This chapter describes the function of MCU.

5.1 Program ROM (PROM)

The PROM is an OTP (One Time Programmable) type memory. The PROM is $2K^*12(0000H \sim 07FFH)$ or $4K^*12(0000H \sim 0FFFH)$ which stores execution program. The last 256 location of effective PROM is reserved area, the user shall not use this area in any case. Assembler shall check user program on this limit. Hardware does not need to check this restriction.

In order to reserved unused area of PROM. These regions maybe use in the future. There is one option "OTPREV" for this purpose. If all unused area of PROM wanted to fill with "0xFFF", the option "OTPREV" on IDE tool must be enabled. Otherwise, they will fill with "0x000".



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PROM=2K

PROM address	Function description
0x0000 ~ 0x0001	Reset
0x0004 ~ 0x0005	Wakeup
0x0008 ~ 0x0009	Interrupt
0x000A ~ 0x06FF	User code
0x0700 ~ 0x07FF	Reserved area

Table 5 Memory Map of PROM 2K

PROM=4K

PROM address	Function description	
0x0000 ~ 0x0001	Reset	
0x0004 ~ 0x0005	Wakeup	
0x0008 ~ 0x0009	Interrupt	
0x000A ~ 0x0EFF	User code	
0x0F00 ~ 0x0FFF	Reserved area	
T.I.I. 0	Manager Manager DDOM 41/	

Table 6 Memory Map of PROM 4K

5.2 Data ROM (DROM)

The DROM is an OTP (One Time Programmable) type memory. It stores the 8-bits wide data for ADPCM or melody data ...etc. There are two types DROM density 28K/24K bytes shown in below table by option. The last 64 locations are a reserved area. The user shall not use this area in any case. Assembler shall check user data ROM on this limit. Hardware does not need to check this restriction. If 2K PROM is selected, the maximum DROM is 28KX8 bytes. If 4K PROM is selected, the maximum DROM is 24KX8 bytes.

PR	OM=2K, DROM=28KX8							
D	ROM address (DMA)	Function description						
0x	(0000 ~ 0x00FF	User area						
0x	(0100 ~ 0x01FF	User area						
0x	(0200 ~ 0x02FF	User area						
· · · ·								
0x	(6FB0 ~ 0x6FBF	User area (Max. size of CST2010A)						
0x	(6FC0 ~ 0x6FFF	System area, last 64 location(don't use it)						
	Table 7 Memory Map of DROM 28K bytes							

mory map or DROW 28K bytes

PROM=4K. DROM=24KX8

DROM address (DMA)	Function description							
0x0000 ~ 0x00FF	User area							
0x0100 ~ 0x01FF	User area							
0x0200 ~ 0x02FF	User area							
0x5FB0 ~ 0x5FBF	User area (Max. size of CST2010A)							
0x5FC0 ~ 0x5FFF	System area, last 64 location(don't use it)							
Table 8 Mor	nory Man of DPOM 24K bytes							

Table 8 Memory Map of DROM 24K bytes

DROM is addressed by four registers DMA3, DMA2, DMA1 and DMA0. After these registers are specified by software, the data need enough delay time, Tdrr in the table of "AC Characteristics". After this delay time, the data can be read from data register (DMDL & DMDH).



LD

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- Ex:
- LD (DMA0), A
 - (DMA3), A
- LD (DMA3), LD A. (DMD
- ; Set DMA0~3
- A, (DMDL) ; Read low nibble data from DROM, address as DMA3~0. A, (DMDH) ; Read high nibble data from DROM, address as DMA3~0.

Symbol	Addr	R/W type	Reset	D3	D2	D1	D0	Description
DMA0	18H	R/W	XXXX	DMA0.3	DMA0.2	DMA0.1	DMA0.0	DMA0~3, four register built a 16-bits addressing
DMA1	19H	R/W	XXXX	DMA1.3	DMA1.2	DMA1.1	DMA1.0	space for read DROM 8-bits data.
DMA2	1AH	R/W	XXXX	DMA2.3	DMA2.2		-	DMA0 is lowest nibble, DMA3 is highest nibble of
DMA3	1BH	R/W	XXXX	DMA3.3	DMA3.2	DMA3.1	DMA3.0	DROM address.
DMDL	1CH	R/W		DMDL.3	DMDL.2	DMDL.1	DMDL.0	Low nibble of DROM data read from this
DIVIDL	юп	K/ VV	XXXX					address.
DMDH				DMDH.3	DMDH.2	DMDH.1	DMDH.0	High nibble of DROM data read from this
	1DH	R/W	xxxx					address.
			~~~~					Write this register means reset watch dog timer if
								this timer is enabled by option.

Table 9 SFRs about DROM

# 5.3 SRAM and Special Function Register

### 5.3.1 SRAM

There are 64 nibbles SRAM in this chip. The SRAM and I/O memory map is divided into two pages by setting MAH register (1-bit wide). The initial value of MAH is unknown and must be defined by instructions "LDMAH" before you utilize SRAM. The extra 2 SRAM nibbles in the specifications and hardware manuals of relative mask ROM products are not SRAM in fact. They are USER1 and USER2 of SFRs.

Direct Ad	dressing	SRAM MAP						
MAH=XH	00H~1FH	SFR(special function register) register						
MAH=0H	20H~3FH	USER SRAM 64x4						
MAH=1H	20H~3FH	USER SRAW 6484						
	Table 10 Memory Map of SFRs							

The first 32-nibble, 00H ~ 1FH, are defined as a common block. Some I/O and user register is arranged in this common block for easy data operations. The other regions, 20H~3FH, are employed as SRAM. The user must notice that the initial content of SRAM is unknown.

# 5.3.2 Special Function Registers

The special function register consists of common I/O and other special register.

A special function register supports LD/ADC/SBC/OR/AND/XOR/INC/DEC/RLC/RRC/CMP/ADR operation. Bit set/clear can only be operated on the address range from 00H to 0FH, except indirect operation is used. The following table describes all of the SFRs.

Symbol	Addr	R/W type	Reset	D3	D2	D1	D0	Description
STATUS	00H	R/W	00xx	reserved	PWFG	CF	ZF	Status Register PWFG: PWM interrupt flag. CF: Carry flag. ZF: Zero flag.
Reserved	01H	-	XXXX	-	-	-	-	Reserved
IOC_PA	02H	R/W	0000	IOCA3	Х	Х	IOCA0	"1" = output, "0" = input of related PA bit.
DATA_PA	03H	R/W	XXXX	DPA3	Х	Х	DPA0	Read from Port A input port and write to output



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								port.	
Reserved	04H~ 06H	-	xxxx	-	-	-	-	Reserved	
USER1	07H	R/W	XXXX	USER1.3	USER1.2	USER1.1	USER1.0	General purpose user register.	
AD_DLL	08H	W	xxxx	AUD_DLL3	AUD_DLL2	AUD_DLL1	AUD_DLL0	AUD_DLL[3:2]: The bit1~0 of 10-bits PWM, combine with AUD_DL[3:0], AUD_DH[3:0] to built 10-bits PWM if option PWM10 is 1 and PWM12 is 0. AUD_DLL[3:0]: The bit3~0 of 12-bits PWM, combine with AUD_DL[3:0], AUD_DH[3:0] to built 12-bits PWM if option PWM12 is 1.	
PWM_CTRL	09H	R/W	x0	reserved	reserved	ENINT	ENPWM	ENPWM: "1" Enable PWM, "0" Disable PWM. ENINT: Enable global interrupt.	
AUD_DL	0AH	W	хххх	AUD_DL3	AUD_DL2	AUD_DL1	AUD_DL0	AUD_DL[3:0]: The low nibble of 8-bits PWM. The bit5~2 of 10-bits PWM. The bit7~4 of 12-bits PWM.	
AUD_DH	0BH	W	хххх	AUD_DH3	AUD_DH2	AUD_DH1	AUD_DH0	AUD_DH[3:0]: The high nibble of 8 bits PWM. The bit9~6 of 10 bits PWM. The bit11~8 of 12 bits PWM. Note: AUD_DH3 is sign bit, "0" means positive.	
Reserved	0CH~ 0EH	-	xxxx	-	-	-	-	Reserved	
USER2	0FH	R/W	XXXX	USER2.3	USER2.2	USER2.1	USER2.0	General purpose user register.	
Reserved	10H								
CNTI	11H	R/W	0000		SCHMIT	S2S	-	S2S: PWM input Data format 1: 2's format 0: sign SCHMIT: PA0 and PA3 Schmitt trigger input SCHMIT=0 disable Schmitt trigger input (default) SCHMIT=1 enable Schmitt trigger input	
Reserved	12H~ 17H	-	xxxx			-		Reserved	
DMA0	18H	R/W	XXXX	DMA0.3	DMA0.2	DMA0.1	DMA0.0	DMA0~3, four register built a 16-bits addressing	
DMA1	19H	R/W	xxxx	DMA1.3	DMA1.2	DMA1.1	DMA1.0	space for read DROM 8-bits data, DMA0 is	
DMA2	1AH	R/W	XXXX	DMA2.3	DMA2.2	DMA2.1	DMA2.0	lowest nibble, DMA3 is highest nibble of DROM	
DMA3	1BH	R/W	XXXX	DMA3.3	DMA3.2	DMA3.1	DMA3.0	address.	
DMDL	1CH	R/W	xxxx	DMDL.3	DMDL.2	DMDL.1	DMDL.0	Low nibble of DROM data read from this address.	
DMDH	1DH	R/W	xxxx	DMDH.3	DMDH.2	DMDH.1	DMDH.0	High nibble of DROM data read from this address. Writing this register means reset watch dog timer if this timer is enabled by option.	
Reserved	1EH~ 1FH	-	хххх		-	-	-	Reserved	

Table 11 All of the Special Function Registers

## 5.4 Interrupt Vector Address

Vector	Address
RESET	00H
WAKEUP	04H
INT	08H

Table 12 Interrupt Vectors



## 5.5 Interrupt Controller

There is only one interrupt entry point in this chip. Normally interrupt period is 32768Hz. Program will jump to address 0x008 when an interrupt occurs.

Symbol	Addr	R/W type	Reset	D3	D2	D1	D0	Description
STATUS	00H	R/W	00xx	reserved	PWFG	CF		Status Register <b>PWFG:</b> PWM interrupt flag. CF: Carry flag. ZF: Zero flag.
PWM_CTRL	09H	R/W	x0	reserved	reserved	ENINT	ENPWM	<b>ENPWM:</b> "1" Enable PWM, "0" Disable PWM. <b>ENINT:</b> Enable global interrupt.

Table 1 SFRs about Interrupt

If the global interrupt enable bit (INTEN) is high and interrupt request (PWFG=1) occurred, then interrupt will be accepted on next clock. On that instant, current (next) program counter, PCDH, MAH and C/Z will be stored in special hardware registers, and program counter will be loaded with entry address of that interrupt. All these are done in one clock. Interrupt enable bit will be cleared too. As long as program enters interrupt service, interrupt enable bit is cleared. It's no need to clear interrupt enable flag in interrupt routine. But hardware will not clear interrupt request flag (PWFG). Software is required to clear it.

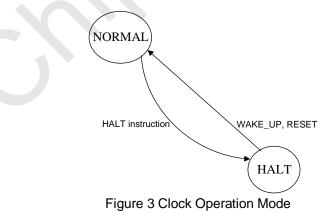
When interrupt service routine is done, an RETI shall be executed. This instruction will restore stored program counter, PCDH, MAH and C/Z, will set interrupt enable bit=1 also. (Note that RETI is different from RETS.) Interrupt request can be accepted only when enable bit be set. Note that only one level of INT routine can be used.

#### 5.6 Clock Operation

There are two operation modes in this chip. The state diagram of three MCU operation modes is shown below:

**1. NORMAL Mode**: In normal mode, system clock oscillator is running, and MCU clock source is come from main oscillator. In NORMAL mode, MCU will go to halt mode after HALT instruction executed.

**2. HALT Mode**: In HALT mode, the MCU clock stops, users can't change the operation mode when in halt mode. It will go back to NORMAL mode (Program counter=0x004) when I/O wakeup or reset occurred. Please refer to the section of "Halt Mode & Wake up" for the detailed HALT mode description.





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#### 5.7 Halt Mode & Wake up

The MCU is changed into HALT mode (program counter and system clock stop) when HALT instruction executed. It provides a power saving mode for those applications requiring a very low stand-by current. The PA[3:0] are supporting the wakeup function when rising edge occurred.

The program counter will be 0x004 when HALT instruction executed immediately, then program counter will go to next address after 352us stable time when wakeup condition occurred. Reset signal will release HALT state and execute reset procedure because reset is first priority when in HALT mode, so program counter will from 0x004 to 0x000, program counter goes to next address after 352us stable time. Furthermore, the SRAM will keep their previous data without changing in this mode.

#### 5.8 Watch Dog Timer Reset (WDT)

The Watch Dog Timer (WDT) is used to reset whole chip when detect unexpected execution sequence caused by accident condition, avoiding dead lock of MCU program. WDT will be reset when wake up from halt, after reset or software clears it. The watch dog timer is a simple counter. It has a fixed length of 0.128 second.

Software must run a "clear watch dog timer" (write to DMDH) instruction before this timer time out when WDT enabled. It will generate a reset signal to reset whole system when WDT over flow. Assembler will check user program about the "reset watch dog" instructions. If more than one "reset watch dog" is found in program, assembler will generate a warning (program code will still be generated). "HALT" instruction will reset watch dog timer. The reset watch dog timer sequence is strongly recommended as:

WATCHDOG:

#### (1DH), A

#### 5.9 8/10/12 Bits PWM

There are three optional PWM output resolutions. One is 8-bits output, the sec. is 10-bits output, and the other is 12-bits output. The highest of input data is signed bit: '0' represents positive, '1' represents negative.

Symbol <	Addr	R/W type	Reset	D3	D2	D1	D0	Description
STATUS	00H	R/W	00xx	reserved	PWFG	CF		Status Register <b>PWFG:</b> PWM interrupt flag. CF: Carry flag. ZF: Zero flag.
AUD_DLL	08H	W	xxxx	AUD_DLL3	AUD_DLL2	AUD_DLL1	AUD_DLL0	AUD_DLL[3:2]: The bit1~0 of 10-bits PWM, combine with AUD_DL[3:0], AUD_DH[3:0] to built 10-bits PWM if option PWM10 is 1 and PWM12 is 0. AUD_DLL[3:0]: The bit3~0 of 12-bits PWM, combine with AUD_DL[3:0], AUD_DH[3:0] to built 12-bits PWM if option PWM12 is 1.
PWM_CTRL	09H	R/W	x0	reserved	reserved	ENINT	ENPWM	<b>ENPWM:</b> "1" Enable PWM, "0" Disable PWM. <b>ENINT:</b> Enable global interrupt.
AUD_DL	0AH	W	хххх	AUD_DL3	AUD_DL2	AUD_DL1	AUD_DL0	AUD_DL[3:0]: The low nibble of 8-bits PWM. The bit5~2 of 10-bits PWM. The bit7~4 of 12-bits PWM.



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	AUD_DH	0BH	W	xxxx	AUD_DH3	AUD_DH2	AUD_DH1	AUD_DH0	AUD_DH[3:0]: The high nibble of 8 bits PWM. The bit9~6 of 10 bits PWM. The bit11~8 of 12 bits PWM. Note: AUD_DH3 is sign bit, "0" means positive.
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Table 2 SFRs about the operation of PWM

#### 5.9.1 8-Bits PWM

This PWM is 8-bits output resolution. An interrupt request happened when a PWM cycle completed.

The MSB of AUD_DH is signed bit, '0' for positive, '1' for negative. PWM output frequency (sample rate) is fixed at 32KHz. PWM data registers are AUD_DL, AUD_DH. The AUL_DL is low nibble (D3 ~ D0). AUD_DH is high nibble (D7 ~ D4). D7 is the signed bit and D6 ~ D0 is the length (clock number) of output active pulse. Software should write AUD_DL and AUD_DH before enable PWM.

When an interrupt request happened, PWM interrupt flag bit PWFG of STATUS register will be "1". The PWM will load previously-written-data into actual conversion port on end of a PWM code output. So program can write data into PWM data store safely at beginning of an interrupt service routine. (A PWM interrupt means PWM data loaded, next data is expected). This timing shall be controlled carefully such that data writing in the beginning of interrupt service routine is safe. If data is not changed during a conversion, previous data will be used.

This PWM output can drive 8 ohm speaker. PWM can be enabled or disabled by setting/clearing ENPWM of PWM_CTRL. When disabled, the PWMP, PWMN pins are all '0'. "HALT" instruction will disable PWM (clear ENPWM of PWM_CTRL) and the PWMP and PWMN pins will be tri-state.

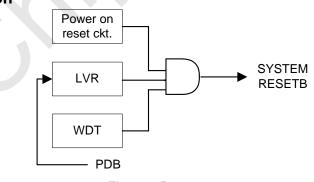
#### 5.9.2 10-Bits PWM

The frequency of PWM clock is fixed at 32 KHz if 10-bits PWM mode is selected by option. The 10-bits PWM data (AUD_DH[3:0], AUD_DL[3:0], AUD_DLL[3:2]) are consist of AUD_DH, AUD_DL, AUD_DLL three registers shown above. The data rage is 0 ~511. Software should write these registers before PWM is enabled. The other features of 10-bits PWM is the same as 8-bits PWM.

#### 5.9.3 12-Bits PWM

The frequency of PWM clock is fixed at 32 KHz if 12-bits PWM mode is selected by option "PWM12S". The 12-bits PWM data (AUD_DH[3:0], AUD_DL[3:0], AUD_DLL[3:0]) are consist of AUD_DH, AUD_DL, AUD_DLL three registers shown above. The data rage is 0 ~ 2047. Software should write these registers before PWM is enabled. The other features of 12-bits PWM is the same as 8-bits PWM.

#### **5.10 Reset Function**





The system reset is come from three signals which are **Power on reset**, **Low voltage reset(LVR)** and **WDT overflow reset**.

For normal operation of this chip, a good reset is needed. The operation frequency of MCU will go back to normal mode when reset occurred in HALT mode.

#### 5.11 System Clock Oscillator

This chip MCU is typically operated on 4.096MHz which is generated from internal RC oscillator 32MHz.

#### 5.12 I/O Ports

There is two I/O port PA3 and PA0, whose input/output direction are defined by IOC_PA. The wakeup functions of PA3 and PA0 are enabled or disabled by option. All I/O ports provides rising or falling edge wakeup function. This double edge wakeup function can be enabled by "BIWK" option. Their 1M/50K Ohm pull down resistors are optional.

#### 5.12.1 Port PA (input/output)

The Port A is 2-bits bidirectional I/O port, they are PA0 and PA3. Their directions can be defined by IOC_PA bit by bit. The following table describe the SFRs associated with Port A.

Symbol	Addr	R/W type	Reset	D3	D2	D1	D0	Description
IOC_PA	02H	R/W	0000	IOCA3	X	Х	IOCA0	"1" = output, "0" = input of related PA bit.
DATA_PA	03H	R/W	xxxx	DPA3	x	x	DPA0	Read from Port A input port and write to output port.

Table 15 SFRs of Ports PA

In output mode, the data can be written out to external pin, and reading this output port will read the data internal latch. Pull-down resistor will be disabled when output mode is selected.

In input mode, Port A data can be read from external pin, and they are attached with 1M/50K Ohm pull-down resistor or not according to the options.

In addition, each pin of Port A also can be accompanied with wakeup function according to the options. In HALT mode, if some bits of Port A are accompanied with wakeup function, any rising edge occurred on that pin will wake up system and turn on oscillator, and the program counter of MCU will jump to the address 0x004. This device will start to execute the wakeup sub-routing.

#### Schmitt trigger input buffers

The Port A pins have Schmitt trigger input buffers. All 4 pins can be configured as Schmitt trigger or normal input selected by register SCHMIT bit..

	Symbol	Addr	R/W type	Reset	D3	D2	D1	D0	Description
	CNTI	11H	R/W	0000		SCHMIT	S2S	-	SCHMIT: PA0 and PA3 Schmitt trigger input SCHMIT=0 disable Schmitt trigger input (default) SCHMIT=1 enable Schmitt trigger input
L						Table			<u> </u>

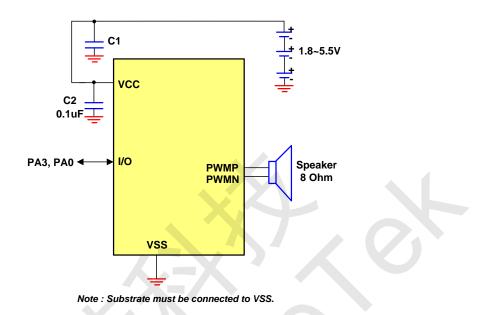
Table 16 SFRs of CNTI

#### Auto power saving mode on PA0 and PA3

If PAO/PA3 acts as an input port with 1M ohm pull down resistor and a button connected between PAO/PA3 and VCC, there has an extra power consumption on 1M ohm if PAO/PA3 key switch keep press from normal mode to HALT mode. Many applications could not accept this extra power consumption when in HALT mode. The CST2010A series are support a power saving mode which change 1M ohm to 3.3M ohm while connecting PAO/PA3 to VCC automatically. The extra current could be decreased from 3uA to 0.9uA @VCC=3V.



# 6. CST2010A The Application Circuit





Notice: C1 : 10 uF ~ 100 uF(depends on applications), C2 : 0.1 uF

## 7. CST2010A Option Registers table

Option Name	Function Description
WAKEBA	Wakeup enable for PA3, PA0 respectively
PD50KPA	50K Ohm pull down resistor for PA0 and PA3 respectively.
PD1MPA	1M Ohm pull down resistor for PA0 and PA3 respectively.
WDGENB	Watch dog timer
HALTENB	HALT mode control
PWM12S	PWM 12 bit selection
PWM10S	PWM 10/8 bit selection
OTPLOCK	Security control
BIWK	Bi-directional wakeup
PROM2K_4K	PROM density 2K/4K selection

Table 17 Option table

#### 8. CST2010A The Revision History

Version	Description	Page	Date
1.0	Established		2024.12.18

Table 18 Revision History